

## PRODUCT DATA SHEET

# SikaMelt®-670

Polyurethane Hot Melt for assembly applications

**TYPICAL PRODUCT DATA (FURTHER VALUES SEE SAFETY DATA SHEET)**

Chemical base	Polyurethane
Color (CQP001-1)	White – beige
Cure mechanism	Moisture curing
Density (uncured)	1.17 kg/l
Viscosity (by Brookfield)	at 130 °C 22 000 mPa·s
Softening temperature (CQP538-5)	65 °C
Application temperature	100 – 160 °C short term max. 1 h 170 °C <sup>A</sup>
Open time (CQP559-1)	Short
Curing time (CQP558-1)	4 h
Green strength (CQP557-1)	after 30 min 2 MPa
Shore D hardness (CQP023-1 / ISO 48-4)	45
Tensile strength (CQP036-3)	25 MPa
Shelf life	9 months

CQP = Corporate Quality Procedure

A) only valid for nozzle

**DESCRIPTION**

SikaMelt®-670 is a reactive polyurethane hot melt adhesive which cures on exposure to atmospheric humidity. With its short open time, high green strength and broad adhesion range it is best suited for fast assembly operations.

**PRODUCT BENEFITS**

- High green strength
- Short open time
- Ideal for assembly operations
- Very good heat and ageing resistance after curing
- Broad adhesion range

**AREAS OF APPLICATION**

SikaMelt®-670 is especially designed for fast assembly applications in diverse areas. It is suitable for permanent bonding of polar plastics as well as for wood, foam, textiles, painted and primed steel. Non polar plastics like PP and PE can be bonded after proper physical pre-treatment. Typical application areas are Automotive interior trim and other industrial assembly operations.

This product is suitable for experienced professional users only. Test with actual substrates and conditions have to be performed to ensure adhesion and material compatibility.

## CURE MECHANISM

SikaMelt®-670 cures by reaction with atmospheric moisture. At low temperatures the water content in the air is lower, which will result in a lower curing speed (see diagram 1). When bonding hydrophobic (e.g. PP) and/or moisture impermeable substrates a significantly longer curing time has to be taken into account.

This applies especially on assembly applications with an adhesive thickness > 100 µm. For lamination applications of hydrophobic and/or moisture impermeable substrates the adhesive layer shall not exceed 100 µm. In such cases project related tests with original substrates and conditions are mandatory.

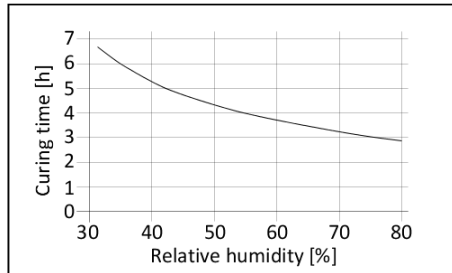


Diagram 1: Curing time for 500 µm film

## CHEMICAL RESISTANCE

SikaMelt®-670 is resistant to aqueous surfactant, weak alkaline/acids solutions and temporarily resistant to fuels, solvents and mineral oils.

The chemical resistance is influenced by several factors such as chemical composition, concentration, period of exposure and temperature. Therefore a project related testing in case of chemical or thermal exposure is required.

## METHOD OF APPLICATION

### Surface preparation

Surfaces must be clean, dry and free from grease, oil and dust.

Based on the surface and type of material, a physical or chemical pre-treatment might be required. Type of pre-treatment must be determined by preliminary tests.

For metals best results are achieved, if substrates are heated up between 40 °C and 60 °C prior the assembly process.

## Application

With adequate processing equipment SikaMelt®-670 can be applied as film, dot, bead or spray application. It is not recommended for roller coater application.

For automated applications a suitable filter system is required.

To meet the required application properties the adhesive viscosity can be adjusted by adapting the application temperature (see table Typical Product Data).

During breaks SikaMelt®-670 is to be processed as follows:

For breaks  $\geq 1$  h the heating needs to be lowered to 80 °C and for breaks  $\geq 4$  h the heating needs to be switched off.

To ensure a constant quality during the whole production process it is mandatory to protect the adhesive in the melting tank with nitrogen, carbon dioxide or dried air (to avoid possible reaction of the product with humidity). At breaks or shut downs dip nozzle in dried oil in order to prevent curing of the adhesive (avoid blockage).

For advice on selecting and setting up suitable processing equipment contact the System Engineering Department of Sika Industry.

## Removal

Equipment and application tools can be cleaned with SikaMelt®-009. Cured material can for cleaning purposes be swelled with SikaMelt®-001 and needs to be removed mechanically (see also cleaning instruction). SikaMelt®-670 may be removed from tools and equipment with Sika® Remover-208 or another suitable solvent.

Hands and exposed skin have to be washed immediately using hand wipes such as Sika® Cleaner-350H or a suitable industrial hand cleaner and water.

Do not use solvents on skin.

## STORAGE CONDITIONS

SikaMelt®-670 has to be stored at temperature below 30 °C in a dry place.

For transportation purposes, the storage temperature can be exceeded for a period of max. 2 weeks up to 60 °C.

## FURTHER INFORMATION

The information herein is offered for general guidance only. Advice on specific applications is available on request from the Technical Department of Sika Industry.

Copies of the following publications are available on request:

- Safety Data Sheets
  - Cleaning Instruction
- For SikaMelt® PUR reactive hot melt equipment

## PACKAGING INFORMATION

Cartridges	330 g
Bag	2 kg
Pail	20 kg
Drum	200 kg

## BASIS OF PRODUCT DATA

All technical data stated in this document are based on laboratory tests. Actual measured data may vary due to circumstances beyond our control.

## HEALTH AND SAFETY INFORMATION

For information and advice on the safe handling, storage and disposal of chemical products, users shall refer to the most recent Safety Data Sheet (SDS) containing physical, ecological, toxicological and other safety-related data.

## DISCLAIMER

The information, and, in particular, the recommendations relating to the application and end use of Sika products, are given in good faith based on Sika's current knowledge and experience of the products when properly stored, handled and applied under normal conditions in accordance with Sika's recommendations. In practice, the differences in materials, substrates and actual site conditions are such that no warranty in respect of merchantability or of fitness for a particular purpose, nor any liability arising out of any legal relationship whatsoever, can be inferred either from this information, or from any written recommendations, or from any other advice offered. The user of the product must test the product's suitability for the intended application and purpose. Sika reserves the right to change the properties of its products. The proprietary rights of third parties must be observed. All orders are accepted subject to our current terms of sale and delivery. Users must always refer to the most recent issue of the local Product Data Sheet for the product concerned, copies of which will be supplied on request.

## PRODUCT DATA SHEET

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